

FEATURES

Complementary to MMBT3906T

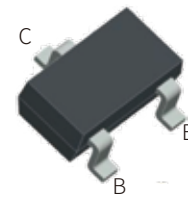
Small Package

MECHANICAL DATA

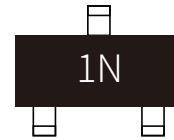
SOT-523 small outline plastic package

Epoxy UL: 94V-0

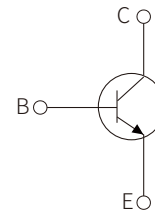
Mounting position: Any



SOT-523



Marking



Schematic Symbol

APPROVALS

RoHS Compliance with 2011/65/EU

HF Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$)

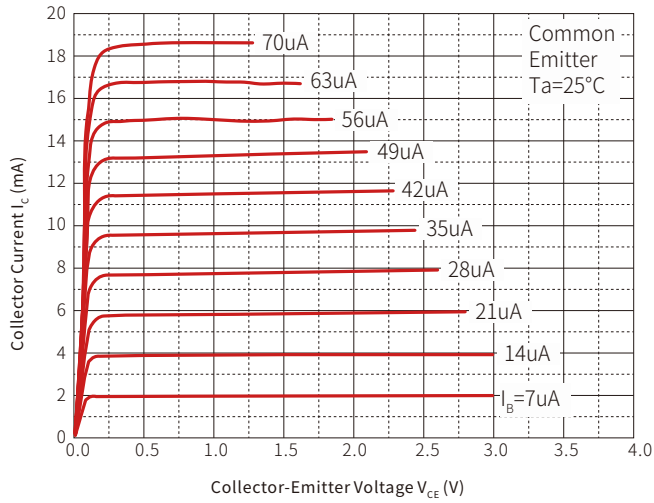
Parameter	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	60	V
Collector-Emitter Voltage	V_{CEO}	40	
Emitter-Base Voltage	V_{EBO}	6	
Collector Current	I_C	200	mA
Collector Power Dissipation	P_C	150	mW
Thermal Resistance From Junction To Ambient	$R_{\theta JA}$	833	$^{\circ}\text{C}/\text{W}$
Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}	-55~+150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS (T_A=25°C)

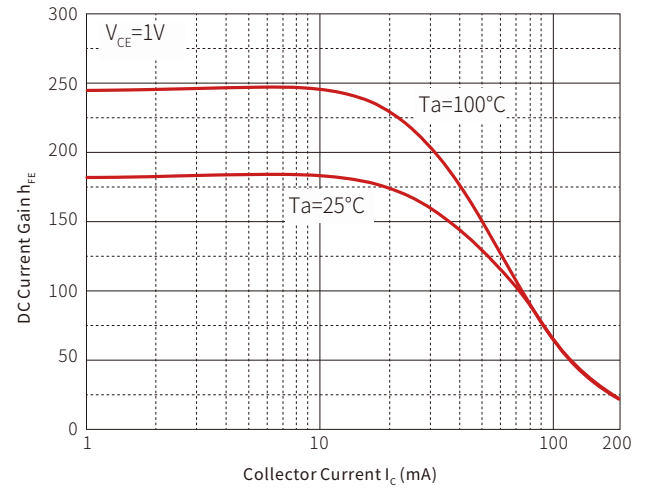
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =10μA, I _E =0	60			V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =1mA, I _B =0	40			
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =10μA, I _C =0	6			
Collector cut-off current	I _{CEX}	V _{CE} =30V, I _C =0			50	nA
Emitter cut-off current	I _{EBO}	V _{EB} =5V, I _C =0			100	
DC current gain	h _{FE}	V _{CE} =1V, I _C =1mA	70			
		V _{CE} =1V, I _C =10mA	100		300	
		V _{CE} =1V, I _C =50mA	60			
Collector-emitter saturation voltage	V _{CE(sat)}	I _C =10mA, I _B =1mA			0.2	V
		I _C =50mA, I _B =5mA			0.3	
Base-emitter saturation voltage	V _{BE(sat)}	I _C =10mA, I _B =1mA	0.65		0.85	V
		I _C =50mA, I _B =5mA			0.95	
Transition frequency	f _T	V _{CE} =20V, I _C =10mA, f=100MHz	300			MHz
Collector output capacitance	C _{ob}	V _{CB} =5V, I _E =0, f=1MHz			4	pF
Input capacitance	C _{ib}	V _{EB} =0.5V, I _C =0, f=1MHz			8	pF
Delay time	t _d	V _{CC} =3V, V _{BE(off)} =-0.5V I _C =10mA, I _{B1} =1mA			35	ns
Rise time	t _r				35	ns
Storage time	t _s	V _{CC} =3V, I _C =10mA I _{B1} =I _{B2} =1mA			200	ns
Fall time	t _f				50	ns

TYPICAL CHARACTERISTICS

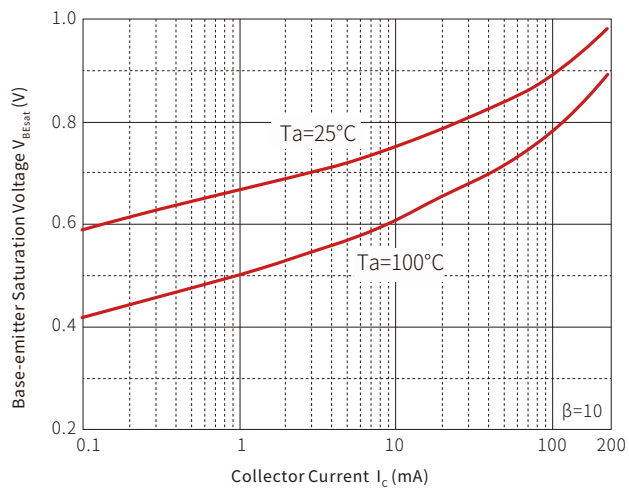
Static Characteristic



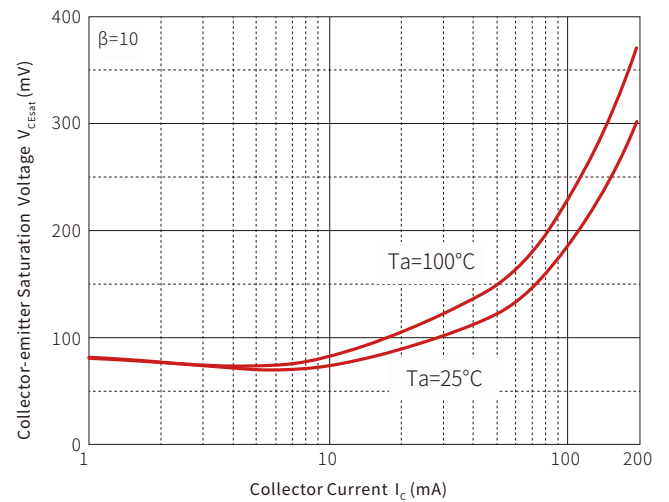
h_{FE} — I_C

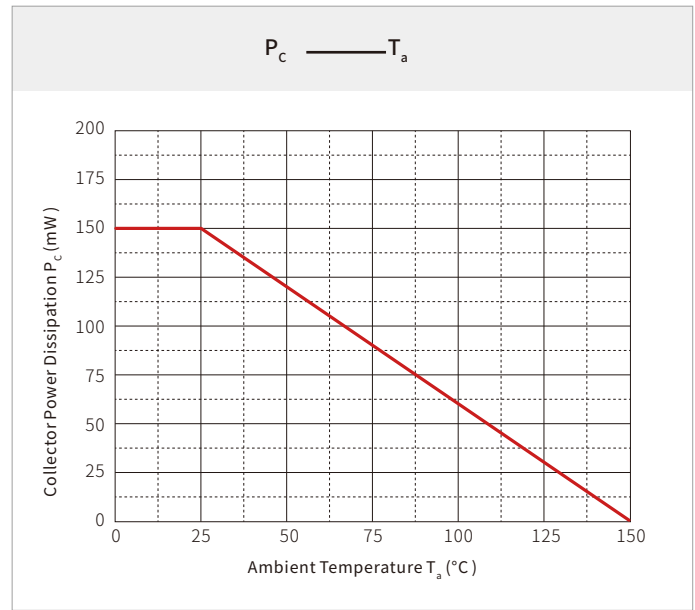
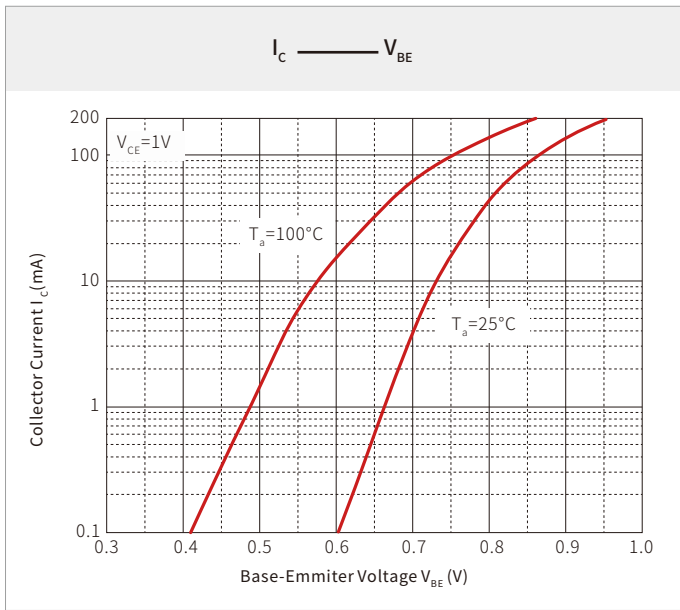


$V_{BE sat}$ — I_C



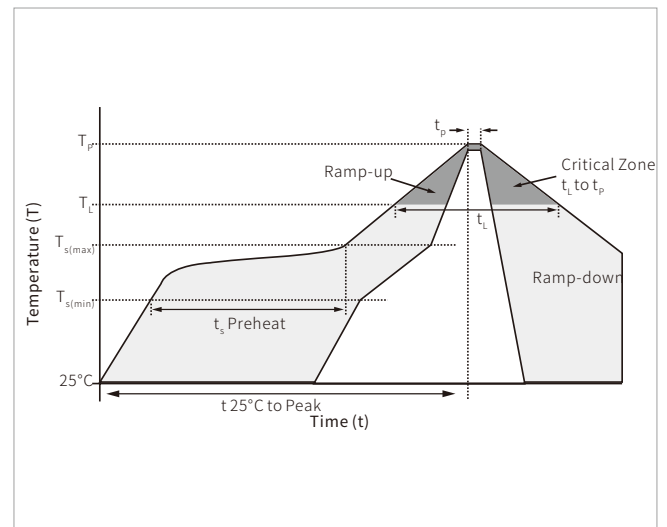
$V_{CE sat}$ — I_C



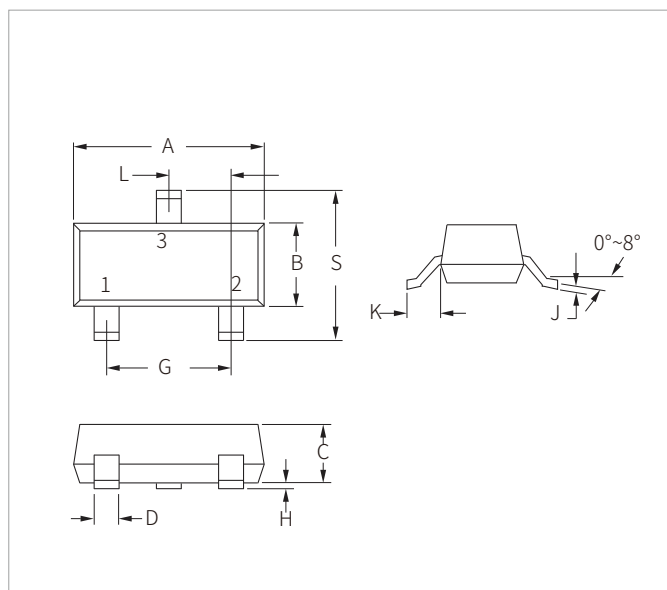


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(\min)}$)	150 $^\circ\text{C}$
	Temperature Max ($T_{s(\max)}$)	200 $^\circ\text{C}$
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		3 $^\circ\text{C}/\text{second}$ max
$T_{s(\max)}$ to T_L - Ramp-up Rate		3 $^\circ\text{C}/\text{second}$ max
Reflow	Temperature (T_L) (Liquidus)	217 $^\circ\text{C}$
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 $^\circ\text{C}$
Time within 5 $^\circ\text{C}$ of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6 $^\circ\text{C}/\text{second}$ max
Time 25 $^\circ\text{C}$ to peak Temperature (T_p)		8 minutes max.
Do not exceed		260 $^\circ\text{C}$

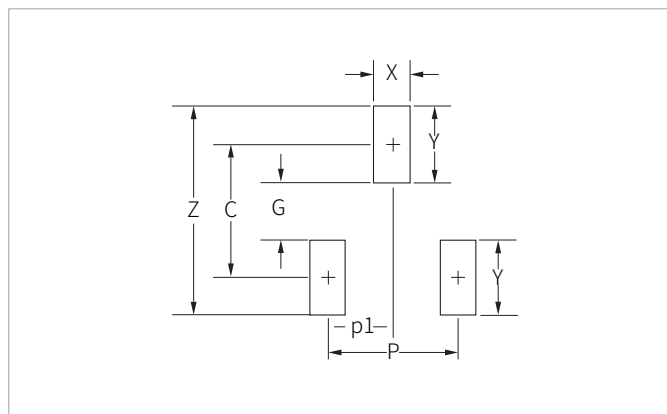


SOT-523 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.50	1.70	0.059	0.067
B	0.70	0.90	0.028	0.035
C	0.60	0.90	0.023	0.035
D	0.15	0.30	0.005	0.012
G	1.00BSC		0.039BSC	
H	0.00	0.10	0.000	0.004
J	0.10	0.20	0.004	0.008
K	(0.22)		(0.009)	
L	0.50BSC		0.020BSC	
S	1.45	1.75	0.057	0.069

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters	Inches
C	(1.40)	(0.055)
P	1.00	0.039
p1	0.50	0.020
G	0.60	0.024
X	0.40	0.016
Y	0.80	0.031
Z	2.20	0.087

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
MMBT3904T	SOT-523	3000PCS	7"

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By QR Code

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